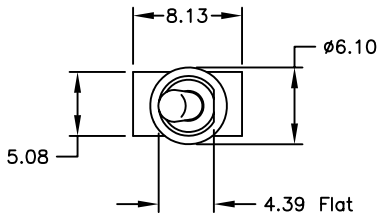
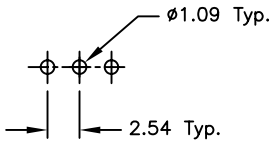
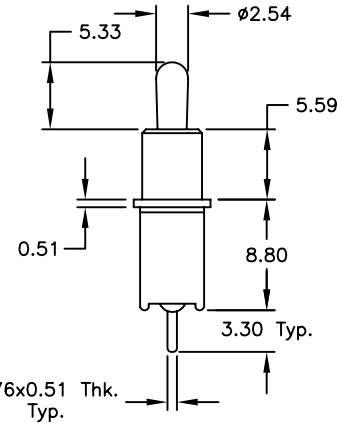
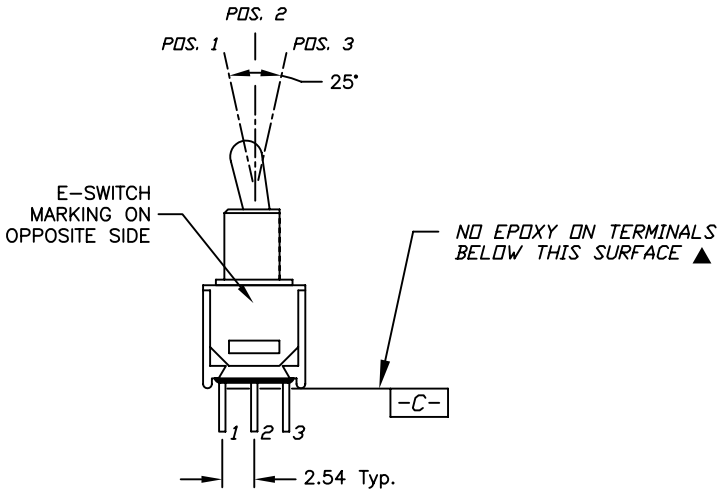
SHEET OF

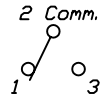



RECOMMEND P.C.B. LAYOUT




CIRCUIT: SPDT
CONTACT CONFIGURATION

| SWITCH FUNCTION | | |
|---|---|---|
| POS. 1 | POS. 2 | POS. 3 |
| ON | NONE | ON |
| 2-3 | OPEN | 2-1 |

NOTES:

1. ALL DIMENSIONS IN MM
2. GENERAL TOLERANCE: 0.0=±0.4
   0.00=±0.25
3. TERM. NOS. FOR REF. ONLY
4. CONTACT RATING: 0.4 (VA) max. @20 VAC or DC max.
5. FIXED TERMINAL & MOVING CONTACT: Cu alloy w/ Au plate over Ni plate.
6. ELECTRIC LIFE: 30,000 make-and-break cycles at full load.
7. INSULATION RESISTANCE: 1,000 M ohm min.
8. DIELECTRIC STRENGTH: 1,000 V RMS @sea level.
9. OPERATING TEMP.: -30°C to 85°C

| REV. | ECN No. | DESCRIPTION | DATE | CHKD |
|---|---|---|---|---|
| A | 10346 | RELEASED FOR PRODUCTION | | |

THE INFORMATION CONTAINED IN THIS DOCUMENT IS PROPRIETARY TO E-SWITCH AND IS NOT TO BE COPIED OR TRANSFERRED

E-SWITCH®

TITLE: 200 MSP-1 T2 B2 M2 R E

| SCALE | DATE | DR | DWG | REV |
|---|---|---|---|---|
| 2:1 | 9/7/99 | MM | T211062 | A |